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VS-ST230S...VPbF Series

Vishay Semiconductors

Phase Control Thyristors (Stud Version), 230 A



PRIMARY CHARACTERISTICS						
I _{T(AV)}	230 A					
V _{DRM} /V _{RRM}	400 V, 800 V, 1200 V					
V _{TM}	1.55 V					
I _{GT}	150 mA					
TJ	-40 °C to +125 °C					
Package	TO-93 (TO-209AB)					
Circuit configuration	Single SCR					

FEATURES

· Center amplifying gate

- International standard case TO-93 (TO-209AB)
- · Glass-metal seal up to 1200 V
- Compression bonded encapsulation for heavy duty operations such as severe thermal cycling
- Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

- DC motor controls
- · Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS						
PARAMETER	TEST CONDITIONS	VALUES	UNITS			
1		230	А			
I _{T(AV)}	T _C	85	°C			
I _{T(RMS)}		360	А			
I	50 Hz	5700	۸			
I _{TSM}	60 Hz	5970	A			
l ² t	50 Hz	163	kA ² s			
1-1	60 Hz	149	KA-S			
V _{DRM} /V _{RRM}		400 to 1200	V			
tq	Typical	100	μs			
TJ		-40 to 125	°C			

ELECTRICAL SPECIFICATIONS

VOLTAGE R	VOLTAGE RATINGS									
TYPE NUMBER	VOLTAGE CODE	V _{DRM} /V _{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	I_{DRM}/I_{RRM} MAXIMUM AT T _J = T _J MAXIMUM mA						
	04	400	500							
VS-ST230S 08		800	900	30						
	12	1200	1300							

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COMPLIANT

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PARAMETER	SYMBOL		TEST CON	IDITIONS	VALUES	UNITS
Maximum average on-state current at case temperature	I _{T(AV)}	180° condu	180° conduction, half sine wave			A °C
Maximum RMS on-state current	I _{T(RMS)}	DC at 78 °C	case temperat	ure	85 360	
	.(t = 10 ms	No voltage		5700	
Maximum peak, one-cycle		t = 8.3 ms	reapplied		5970	A
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}	Sinusoidal half wave,	4800	
		t = 8.3 ms	reapplied		5000	
Maximum I ² t for fusing	l ² t	t = 10 ms	No voltage	initial $T_J = T_J$ maximum	163	- kA ² s
		t = 8.3 ms	reapplied	-	148	
Maximum 1-t for fusing		t = 10 ms	100 % V _{RRM}		115	
		t = 8.3 ms	reapplied		105	
Maximum I ² √t for fusing	l²√t	t = 0.1 to 10) ms, no voltage	reapplied	1630	kA²√s
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π	$x \ I_{T(AV)} < I < \pi \ x$	$I_{T(AV)}$), $T_J = T_J$ maximum	0.92	v
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)})$	$(I > \pi \times I_{T(AV)}), T_J = T_J maximum$			v
Low level value of on-state slope resistance	r _{t1}	$(16.7 \% x \pi x I_{T(AV)} < I < \pi x I_{T(AV)}), T_J = T_J maximum$			0.88	mΩ
High level value of on-state slope resistance	r _{t2}	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			0.81	11122
Maximum on-state voltage	V _{TM}	$I_{pk} = 720 \text{ A}, T_J = T_J \text{ maximum, } t_p = 10 \text{ ms sine pulse}$			1.55	V
Maximum holding current	Ι _Η	T _ 25 °C	anada aunalu 1	2 V registive load	600	mA
Maximum (typical) latching current	١L	$1_{\rm J} = 25^{-1}{\rm C},$	anoue supply 1	2 V resistive load	1000 (300)	

SWITCHING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum non-repetitive rate of rise of turned-on current	dl/dt	Gate drive 20 V, 20 $\Omega,$ $t_r \leq 1~\mu s$ $T_J = T_J$ maximum, anode voltage $\leq 80~\%~V_{DRM}$	1000	A/µs	
Typical delay time	t _d	Gate current 1 A, dl _g /dt = 1 A/ μ s V _d = 0.67 % V _{DRM} , T _J = 25 °C	1.0		
Typical turn-off time t _q		I_{TM} = 300 A, T_J = T_J maximum, dI_F/dt = 20 A/µs, V_R = 50 V, dV/dt = 20 V/µs, gate 0 V 100 $\Omega,$ t_p = 500 µs	100	μs	

BLOCKING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum linear to 80 % rated V_{DRM}	500	V/µs
Maximum peak reverse and off-state leakage current	I _{RRM} , I _{DRM}	$T_J = T_J$ maximum, rated V_{DRM}/V_{RRM} applied	30	mA



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TRIGGERING						
PARAMETER	SYMBOL	т	EST CONDITIONS	VALUES		UNITS
PANAMETEN	STNIBOL		TEST CONDITIONS		MAX.	UNITS
Maximum peak gate power	P _{GM}	$T_J = T_J$ maximum,	$t_p \le 5 ms$	10).0	W
Maximum average gate power	P _{G(AV)}	$T_J = T_J$ maximum,	f = 50 Hz, d% = 50	2	.0	vv
Maximum peak positive gate current	I _{GM}	$T_J = T_J$ maximum,	$t_p \le 5 ms$	3	.0	А
Maximum peak positive gate voltage	+V _{GM}	$T_{J} = T_{J} maximum,$	t < 5 mg	2	0	V
Maximum peak negative gate voltage	-V _{GM}	ij = ij maximum,	$t_p \ge 0$ ms	5.0		v
	I _{GT}	T _J = - 40 °C		180	-	
DC gate current required to trigger		T _J = 25 °C	Maximum required acts triager/	90	150	mA
		T _J = 125 °C	Maximum required gate trigger/ current/voltage are the lowest	40	-	
		T _J = - 40 °C	value which will trigger all units 12 V anode to cathode applied	2.9	-	
DC gate voltage required to trigger	V _{GT}	T _J = 25 °C		1.8	3.0	V
		T _J = 125 °C		1.2	-	
DC gate current not to trigger	I _{GD}	Maximum gate current/voltag to trigger is the maximum		1	0	mA
DC gate voltage not to trigger	V _{GD}	$T_J = T_J maximum$	which will not trigger any unit with rated V _{DRM} anode to cathode applied			V

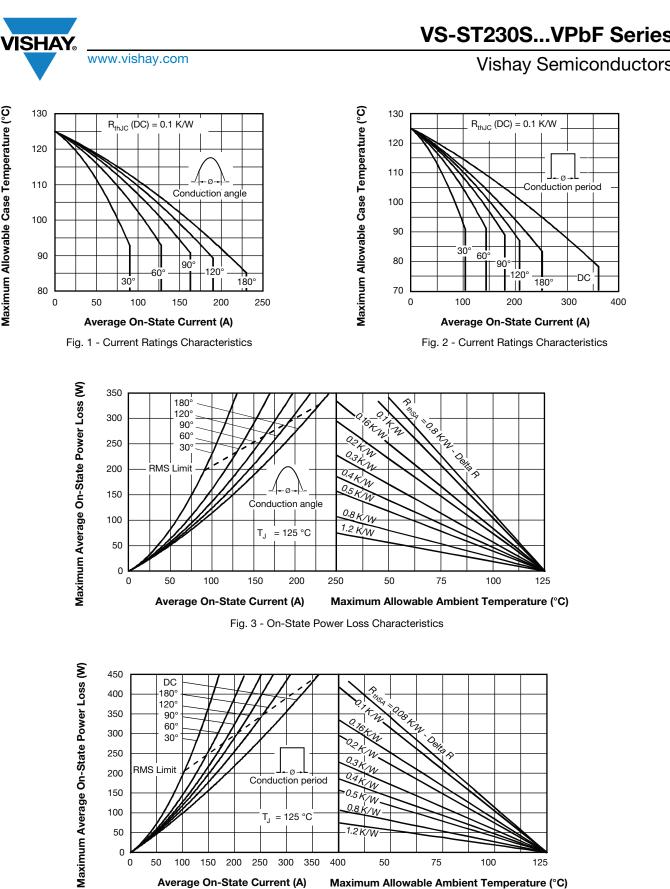
THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum operating junction temperature range	TJ		-40 to 125	°C	
Maximum storage temperature range	T _{Stg}		-40 to 150		
Maximum thermal resistance, junction to case	R _{thJC}	R _{thJC} DC operation		K/W	
Maximum thermal resistance, case to heatsink	R _{thC-hs}	Mounting surface, smooth, flat and greased	0.04	r∨ vv	
Mounting torgue, ± 10 %		Non-lubricated threads	31 (275)	N·m	
		Lubricated threads	24.5 (210)	(lbf · in)	
Approximate weight			280	g	
Case style		See dimensions - link at the end of datasheet	TO-93 (TO-2	209AB)	

CONDUCTION ANGLE	SINUSOIDAL CONDUCTION	RECTANGULAR CONDUCTION	TEST CONDITIONS	UNITS			
180°	0.016	0.012					
120°	0.019	0.020					
90°	0.025	0.027	$T_J = T_J maximum$	K/W			
60°	0.036	0.037					
30°	0.060	0.060					

Note

• The table above shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

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Maximum Allowable Case Temperature (°C)

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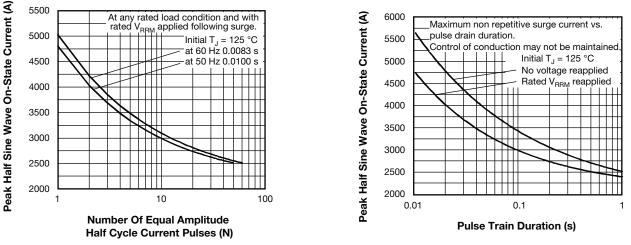


Fig. 5 - Maximum Non-Repetitive Surge Current



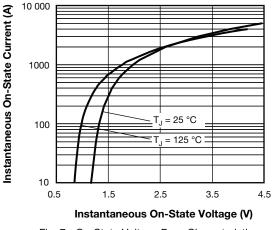


Fig. 7 - On-State Voltage Drop Characteristics

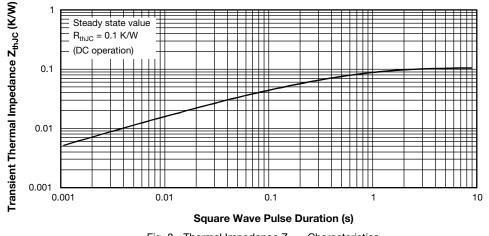
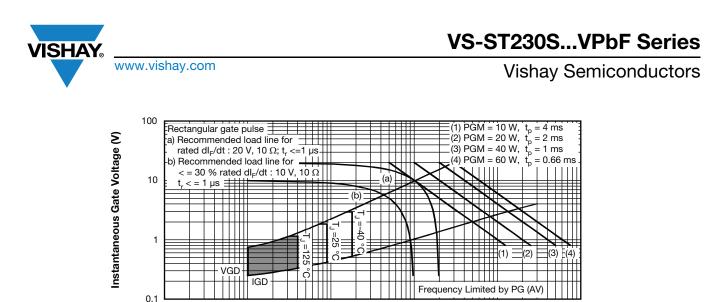


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics

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Instantaneous Gate Current (A) Fig. 9 - Gate Characteristics

1

10

100

0.1

ORDERING INFORMATION TABLE

0.001

0.01

Device code	VS-	ST	23	0	S	12	Р	0	v	PbF
	1	2	3	4	5	6	7	8	9	10
	1 - 2 -	Thy	ristor	niconduc	-	oduct				
	3 - 4 -	0 =	convert	art numt er grade)	tu d				
	5 - 6 -	Volt	age coo	ession bo le x 100	= V _{RRN}	/ (see V	-	Ratings	table)	
	 P = stud base 3/4"-16UNF2A threads 0 = eyelet terminals (gate and auxiliary cathode leads) 1 = fast-on terminals (gate and auxiliary cathode leads) 									
	9 -	V =	glass-m	netal sea	al (only	up to 12		athode in	eads)	
				ndard pr (Pb)-fre		n				
	Note: For metric device M16 x 1.5 contact factory									

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95082			

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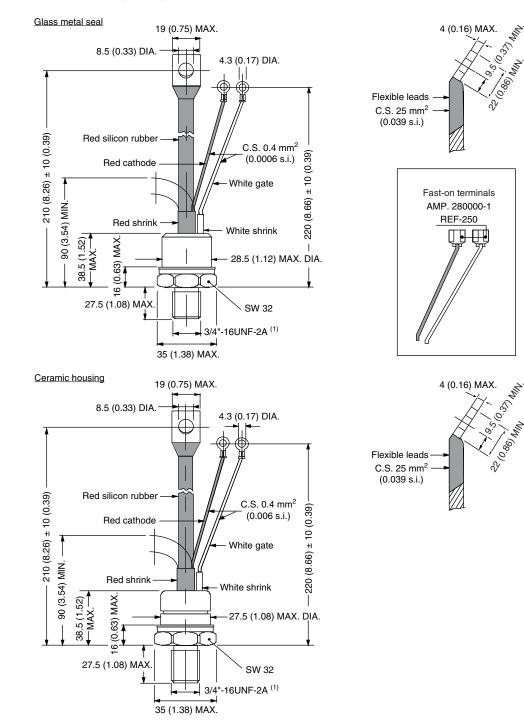
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NIN,



DIMENSIONS in millimeters (inches)

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Note

⁽¹⁾ For metric device: M16 x 1.5 - length 21 (0.83) maximum

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